

SIEMENS

SFH620AA/AGB

5.3 kV TRIOS® Optocoupler AC Voltage Input

FEATURES

- **High Current Transfer Ratios**
at 5 mA: 50–600%
at 1 mA: 45% typical (>13)
- **Low CTR Degradation**
- **Good CTR Linearity Depending on Forward Current**
- **Isolation Test Voltage, 5300 VAC_{RMS}**
- **High Collector-Emitter Voltage, V_{CEO}=70 V**
- **Low Saturation Voltage**
- **Fast Switching Times**
- **Field-Effect Stable by TRIOS (TTransparent IOn Shield)**
- **Temperature Stable**
- **Low Coupling Capacitance**
- **End-Stackable, .100" (2.54 mm) Spacing**
- **High Common-Mode Interference Immunity (Unconnected Base)**
- **Underwriters Lab File #52744**
-  **VDE 0884 Available with Option 1**
- **SMD Option, See SFH6206 Data Sheet**

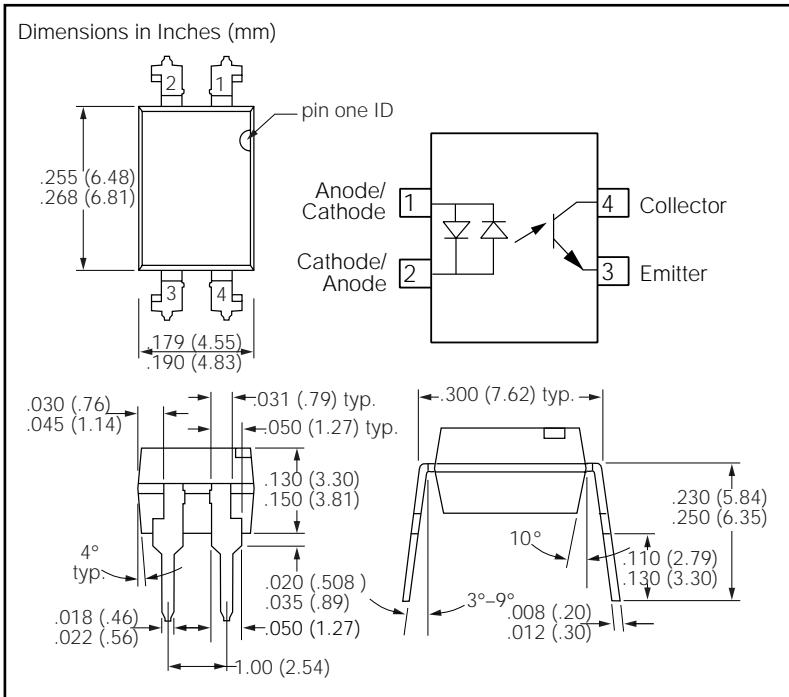
DESCRIPTION

The SFH620AA/AGB features a high current transfer ratio, low coupling capacitance and high isolation voltage. These couplers have a GaAs infrared emitting diode emitter, which is optically coupled to a silicon planar phototransistor detector, and is incorporated in a plastic DIP-4 package.

The coupling devices are designed for signal transmission between two electrically separated circuits.

The couplers are end-stackable with 2.54 mm spacing.

Creepage and clearance distances of >8 mm are achieved with option 6. This version complies with IEC 950 (DIN VDE 0805) for reinforced insulation up to an operation voltage of 400 V_{RMS} or DC.



Maximum Ratings

Emitter

| | |
|---|--------|
| Reverse Voltage | ±60 mA |
| Surge Forward Current (t _P ≤10 μs) | ±2.5 A |
| Total Power Dissipation | 100 mW |

Detector

| | |
|--|--------|
| Collector-Emitter Voltage | 70 V |
| Emitter-Collector Voltage | 7 V |
| Collector Current | 50 mA |
| Collector Current (t _P ≤1 ms) | 100 mA |
| Total Power Dissipation | 150 mW |

Package

| | |
|--|-------------------------|
| Isolation Test Voltage between Emitter and Detector, refer to Climate DIN 40046, part 2, Nov. 74 | 5300 VAC _{RMS} |
| Creepage | ≥7 mm |
| Clearance | ≥7 mm |
| Insulation Thickness between Emitter and Detector | 0.4 mm |
| Comparative Tracking Index per DIN IEC 112/VDEO 303, part 1 | 175 |
| Isolation Resistance | |
| V _{IO} =500 V, T _A =25°C | ≥10 ¹² Ω |
| V _{IO} =500 V, T _A =100°C | ≥10 ¹¹ Ω |
| Storage Temperature Range | -55 to +150°C |
| Ambient Temperature Range | -55 to +100°C |
| Junction Temperature | 100°C |
| Soldering Temperature (max. 10 s. Dip Soldering Distance to Seating Plane ≥1.5 mm) | 260°C |

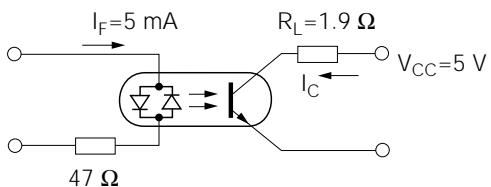
Characteristics (T_A=25°C)

| Description | Symbol | | Unit | Condition |
|--------------------------------------|--------------------|---------------------|------|---|
| Emitter | | | | |
| Forward Voltage | V _F | 1.25 (\leq 1.65) | V | I _F = \pm 60 mA |
| Capacitance | C ₀ | 50 | pF | V _R =0 V, f=1 MHz |
| Thermal Resistance | R _{thJA} | 750 | K/W | |
| Detector | | | | |
| Capacitance | C _{CE} | 6.8 | pF | V _{CE} =5 V, f=1 MHz |
| Thermal Resistance | R _{thJA} | 500 | K/W | |
| Package | | | | |
| Collector-Emitter Saturation Voltage | V _{CESAT} | 0.25 (\leq 0.4) | V | I _F =10 mA, I _C =2.5 mA |
| Coupling Capacitance | C _C | 0.2 | pF | |

Note: 1. Still air, coupler soldered to PCB or base.

Current Transfer Ratio (I_C/I_F at V_{CE}=5 V) and Collector-Emitter Leakage Current

| Description | AA | AGB | Unit |
|--|------------------|------------------|------|
| I _C /I _F (I _F = \pm 5 mA) | 50–600 | 100–600 | % |
| Collector-Emitter Leakage Current, I _{CEO} V _{CE} =10 V | 10 (\leq 100) | 10 (\leq 100) | nA |

Switching Times (Typical Values)
Linear Operation (saturated)


| | | | |
|---------------|------------------|-----|----|
| Turn-on Time | t _{ON} | 2.0 | μs |
| Turn-off Time | t _{OFF} | 25 | μs |

Figure 1. Current transfer ratio (typ.) vs. temperature

$I_F = 10 \text{ mA}$, $V_{CE} = 5 \text{ V}$

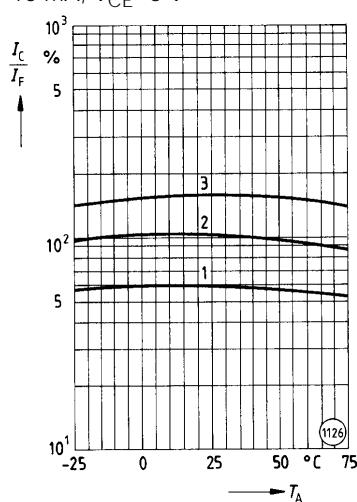


Figure 2. Output characteristics (typ.) Collector current vs. collector-emitter voltage $T_A = 25^\circ\text{C}$

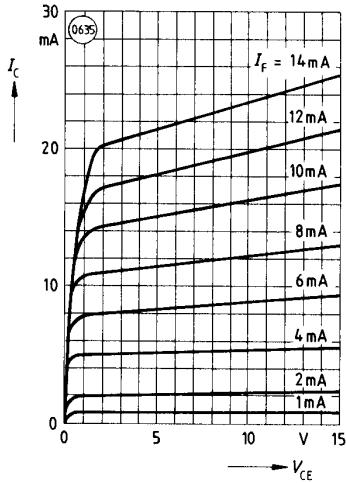


Figure 3. Diode forward voltage (typ.) vs. forward current

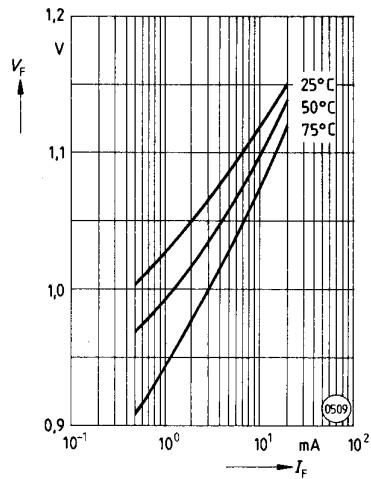


Figure 4. Transistor capacitance (typ.) vs. collector-emitter voltage

$T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$

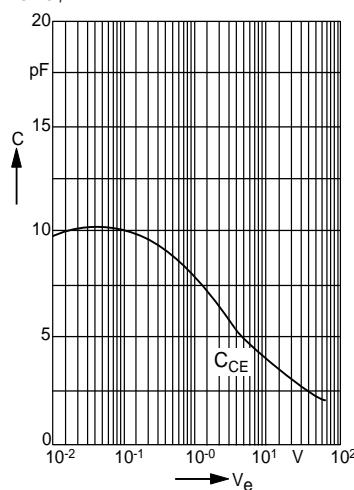


Figure 5. Permissible pulse handling capability. Fwd. current vs. pulse width
Pulse cycle D=parameter, $T_A = 25^\circ\text{C}$

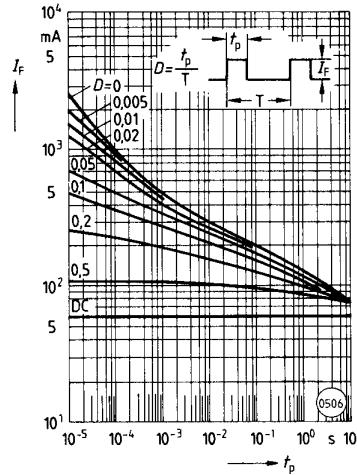


Figure 6. Permissible power dissipation vs. ambient temp.

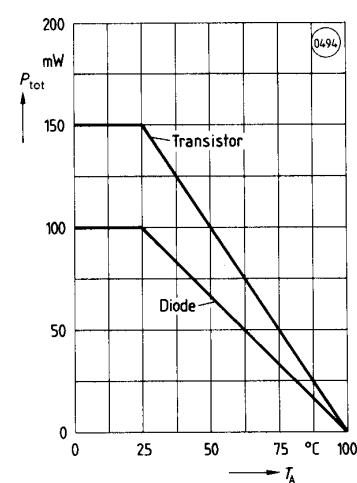


Figure 7. Permissible diode forward current vs. ambient temp.

